

# HSF

**NOTES:**

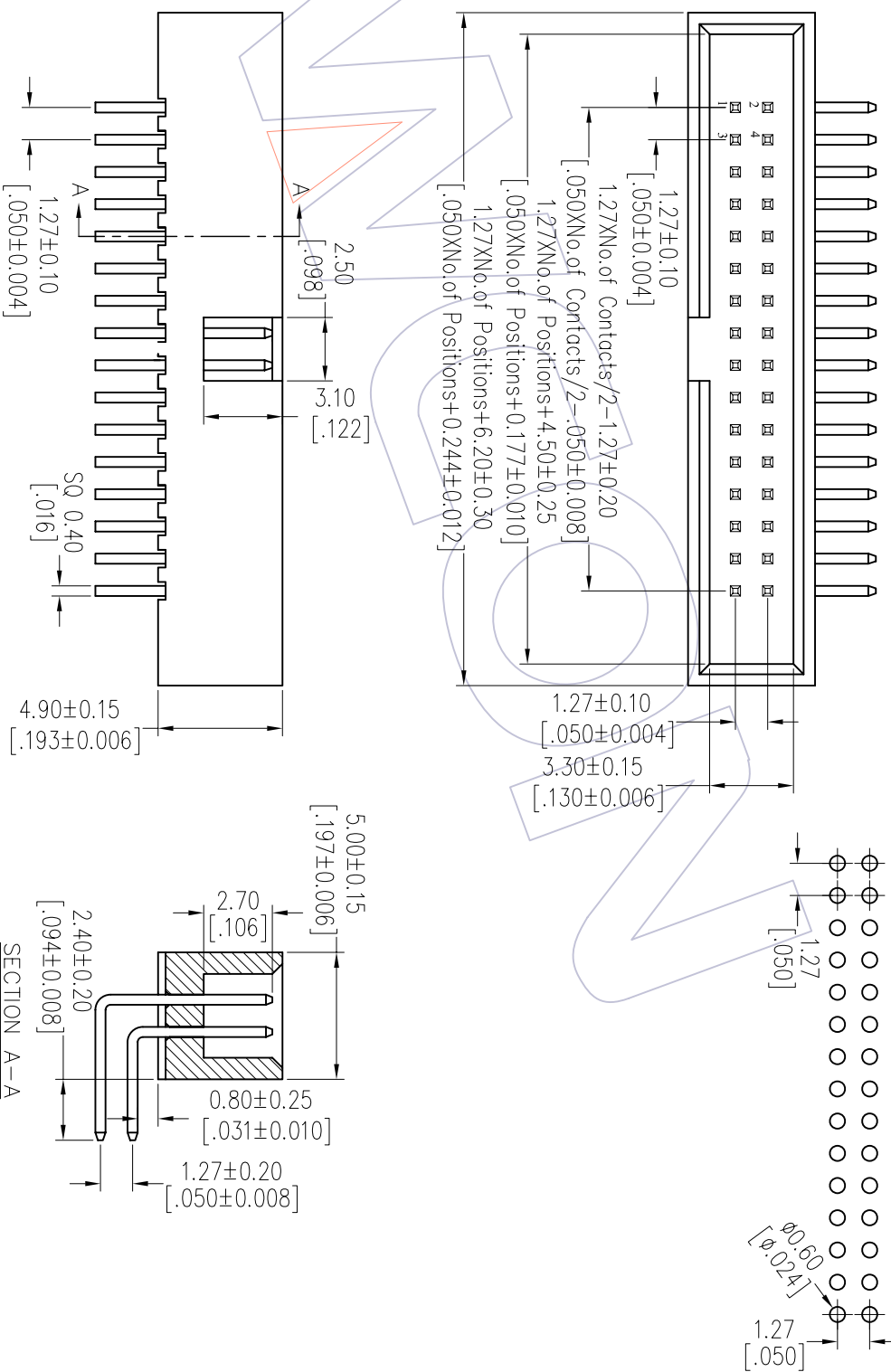
- Current Rating: 1.0AMP
- Contact Resistance: 20mΩ Max
- Withstand Voltage: 500V AC/DC
- Insulation Resistance: 1000MΩ Min
- Operation Temperature: -40°C to +105°C
- Contact Material: Brass
- Contact plating: Au Or Sn over Ni
- Insulator Material: PA9T+30%G.F. UL94V-0

## Ordering Information

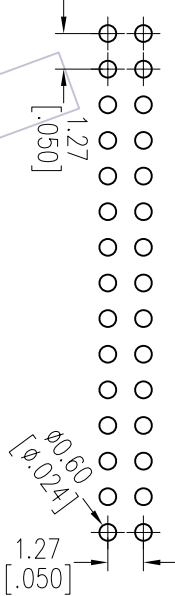
3130-XX R XX BK 00 X 1

No. of Pins	Contact Plating	Color	Insulator	Packing
10 34	G0=Gold Flash	B=Black		T=Tube
14 40	G3=10u"Gold	W=White		
16 44	G4=15u"Gold			
20 50	G5=30u"Gold			
24 60	S0=Gold Flash/Tin			
26 64	S3=10u"Gold/Tin			
30 80	S4=15u"Gold/Tin			
32 100	S5=30u"Gold/Tin			
	SN=Tin			

Item	Pitch	Mating
Standard	1.27	5232/2334
Alternate		



Recommended P.C.B Layout(Top Side)  
(PCB BOARD TOLERANCE±0.05)



OPERATION		DRAW		DATE		SCALE		FIT		PART NO.	
XX	±0.40	JYHuang		2012/09/13		mm				3130-XXRXXBK00X1	
XX	±0.25	CHECK		DATE		A4				TITLE:	
X.XXX	±0.15					1/1				1.27 BOX HEADER 90° H=4.90	
Angle	± 3°	APPROVE		DATE						Customer NO.	
DIM	TOL					PROJ.					
MODIFICATION DESCRIPTION		CHANGE		DIM		TOL					
REV	DATE										
A0	2012/09/13	NEW									

# WCON

Http: www.wcon.com

WCON-Dongguan  
Tel: +86 769 85358920  
Fax: +86 769 85358915  
E-mail: sales@wcon.com

WCON-Kunshan  
Tel: +86 512 57468408  
Fax: +86 512 57468468  
E-mail: sales@wcon.com